Electronic Patent Application Fee Transmittal								
Application Number:	10568	10568410						
Filing Date:	14-Feb	14-Feb-2006						
Title of Invention:	MOLDING COMPOUND							
First Named Inventor/Applicant Name:	Domo	Domonique Teyssie						
Filer:	Marvir	Marvin Jay Spivak/April Foubare						
Attorney Docket Number:	28561	285619US0PCT						
Filed as Large Entity								
U.S. National Stage under 35 USC 371 Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:	•		·					
Pages:								
Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Post-Allowance-and-Post-Issuance:								
Extension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
	Total in USD (\$)			810